

Z-PACK | Z-PACK 2mm HM

TE Internal #: 1857990-1

PCB Mount Receptacle, 1 Gb/s, 25 Column, 5 Row, Traditional Backplane, 125 Position, Z-PACK 2mm HM, Hard Metric Backplane

Connectors

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Connectors > PCB Connectors > Backplane Connectors > Hard Metric Backplane Connectors



PCB Connector Assembly Type: PCB Mount Receptacle

Data Rate: 1 Gb/s

Number of Columns: 25
Number of Rows: 5

Backplane Architecture: Traditional Backplane

Features

Product Type Features

Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Receptacle
Sealable	No
Configuration Features	
Number of Columns	25
Number of Rows	5
Backplane Architecture	Traditional Backplane
Number of Positions	125
PCB Mount Orientation	Right Angle
Signal Characteristics	
Data Rate	1 Gb/s

Gray

Body Features

Primary Product Color



Contact Features	
CompactPCI Designation	None
Contact Underplating Material	Nickel
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]
Contact Current Rating (Max)	1.5 A
Mechanical Attachment	
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Glass-Filled Polyester
Centerline (Pitch)	2 mm[.079 in]
Usage Conditions	
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	11
Packaging Method	Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900



ppm.

Solder Process Capability

Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Z-PACK 2mm HM



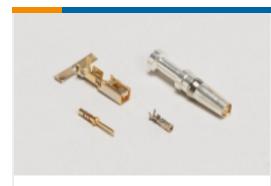
Backplane Connector Housings(4)



Backplane Power Connectors(6)



Connector Caps & Covers(62)



Connector Contacts(2)



Connector Hardware(97)



Hard Metric Backplane Connectors



High Speed Backplane Connectors(1)



Insertion & Extraction Tools(2)





Customers Also Bought



















Documents

Product Drawings

Z-PACK/B F-HDR.125P, EON

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1857990-1_A.2d_dxf.zip



English

Customer View Model

ENG_CVM_CVM_1857990-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1857990-1_A.3d_stp.zip

English

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Product Specifications

Application Specification

English